

#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

### **Product Summary**

Device	BV <sub>DSS</sub>	Rds(ON) Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
Q1	201/	$30m\Omega$ @ V <sub>GS</sub> = $10V$	5.3A
N-Channel	N-Channel 30V	$42m\Omega$ @ VGS = $4.5V$	4.5A
Q2	201/	70mΩ @ V <sub>GS</sub> = -10V	-3.4A
P-Channel	-30V	100mΩ @ V <sub>GS</sub> = -4.5V	-2.9A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- · Body control electronics
- Power management functions
- DC-DC converters

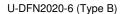
### **Features and Benefits**

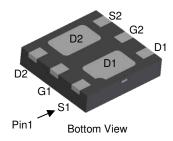
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

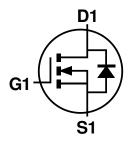
https://www.diodes.com/quality/product-definitions/

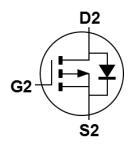
#### **Mechanical Data**

- Package: U-DFN2020-6
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)









Internal Schematic

## Ordering Information (Note 4)

Part Number	Dookogo	Pac	Packing		
Part Number	Package	Qty.	Carrier		
DMC3032LFDB-7	U-DFN2020-6 (Type B)	3,000	Tape & Reel		
DMC3032LFDB-13	U-DFN2020-6 (Type B)	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**



BH = Product Type Marking Code
YWX = Date Code Marking
Y = Year (ex: 2 = 2022)
W = Week (ex: a = Week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Υ	Z

## Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit
Drain-Source Voltage			VDSS	30	-30	V
Gate-Source Voltage			Vgss	±20	±20	V
Continuous Drain Current (Note 5) VGS = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +75^{\circ}C$	ID	5.3 4.2	-3.4 -2.7	Α
Maximum Continuous Body Diode Forward Cur	rent (Note	5)	Is	1.6	-1.2	Α
Pulsed Body Diode Forward Current (370µs Pul	se, Duty C	Cycle = 1%)	lsм	20	-20	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	20	-20	Α
Avalanche Current (Note 6) L = 0.1mH			IAS	12	-14	Α
Avalanche Energy (Note 6) L = 0.1mH			Eas	10	10	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)		PD	0.8	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{ heta JA}$	149	°C/W
Total Power Dissipation (Note 5)		PD	1.28	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	98	°C/W
Operating and Storage Temperature Range		ТJ, Tsтg	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

6.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25$ °C.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



# Electrical Characteristics Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	-		V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_		1.0	μΑ	$V_{DS} = 30V$ , $V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	_	2.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	Process	_	24	30	mΩ	$V_{GS} = 10V, I_D = 5.8A$
Static Drain-Source Off-Nesistance	RDS(ON)	_	30	42	11152	$V_{GS} = 4.5V, I_{D} = 4.8A$
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	500		рF	\\ 45\\\\\ 0\\
Output Capacitance	Coss	_	52		pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	44		pF	1 = 1.000112
Gate Resistance	$R_g$	_	2.3		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (VGS = 4.5V)	Qg	_	5.0		nC	
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	_	10.6	_	nC	V <sub>DS</sub> = 15V, I <sub>D</sub> = 5.8A
Gate-Source Charge	Qgs	_	1.3	_	nC	VDS = 15V, ID = 5.6A
Gate-Drain Charge	Qgd	_	1.8	_	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	2.2	_	ns	
Turn-On Rise Time	tr	_	2.6	_	ns	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V
Turn-Off Delay Time	tD(OFF)	_	9.7	_	ns	$R_L = 2.6\Omega$ , $R_G = 3\Omega$
Turn-Off Fall Time	tF	_	2.0	_	ns	

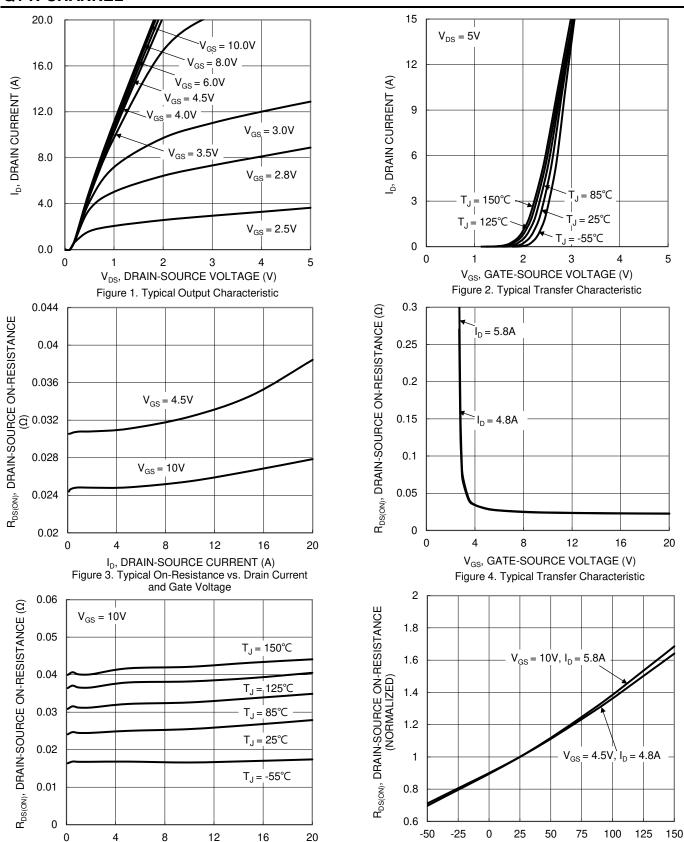
# Electrical Characteristics Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_		V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS		_	-1.0	μΑ	$V_{DS} = -30V$ , $V_{GS} = 0V$
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	_	-2.1	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
Static Drain-Source On-Resistance	Pro/ONI)	_	53	70	mΩ	$V_{GS} = -10V, I_D = -3.8A$
Static Dialif-Source Off-Nesistance	RDS(ON)		75	100	11152	$V_{GS} = -4.5V$ , $I_{D} = -3.0A$
Diode Forward Voltage	V <sub>SD</sub>		-0.8	-1.2	V	$V_{GS} = 0V$ , $I_{S} = -2.7A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		336		pF	Vac 05V Vac 0V
Output Capacitance	Coss		70	_	pF	VDS = -25V, VGS = 0V -f = 1.0MHz
Reverse Transfer Capacitance	Crss		49		pF	1 - 1.000112
Gate Resistance	Rg		4.6		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg		4.0		nC	
Total Gate Charge (VGS = -10V)	Qg		7.8		nC	V <sub>DS</sub> = -15V, I <sub>D</sub> = -3.8A
Gate-Source Charge	Qgs	_	1.0	_	nC	VDS = -15V, ID = -3.6A
Gate-Drain Charge	$Q_{gd}$		2.5		nC	
Turn-On Delay Time	t <sub>D(ON)</sub>		6.0		ns	
Turn-On Rise Time	tr		5.0		ns	V <sub>DD</sub> = -15V, V <sub>GS</sub> = -10V
Turn-Off Delay Time	tD(OFF)		17.6	_	ns	$ID = -1A$ , $R_G = 6\Omega$
Turn-Off Fall Time	t <sub>F</sub>		9.5	_	ns	

8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:



### **Q1 N-CHANNEL**



I<sub>D</sub>, DRAIN CURRENT (A)

Figure 5. Typical On-Resistance vs. Drain Current and

Temperature

T<sub>.i</sub>, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with

Junction Temperature



### Q1 N-CHANNEL (continued)

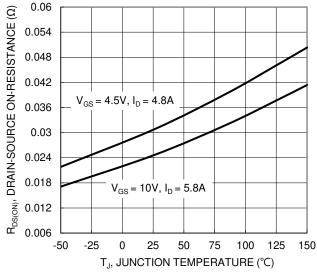


Figure 7. On-Resistance Variation with Temperature

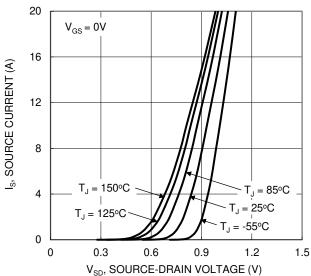


Figure 9. Diode Forward Voltage vs. Current

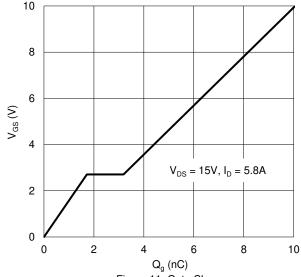


Figure 11. Gate Charge

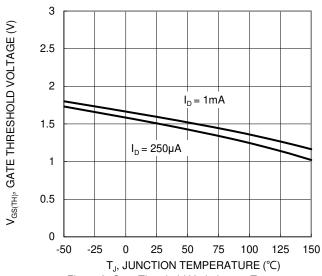


Figure 8. Gate Threshold Variation vs. Temperature

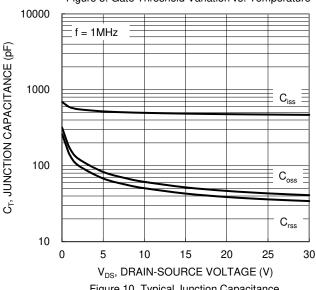
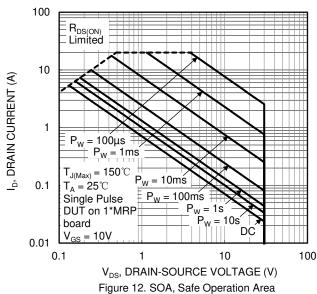


Figure 10. Typical Junction Capacitance





# Q1 N-CHANNEL (continued)

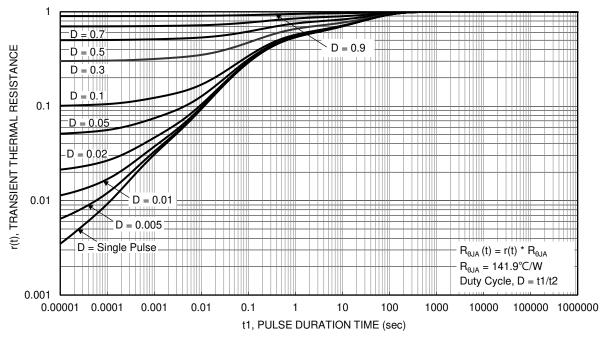
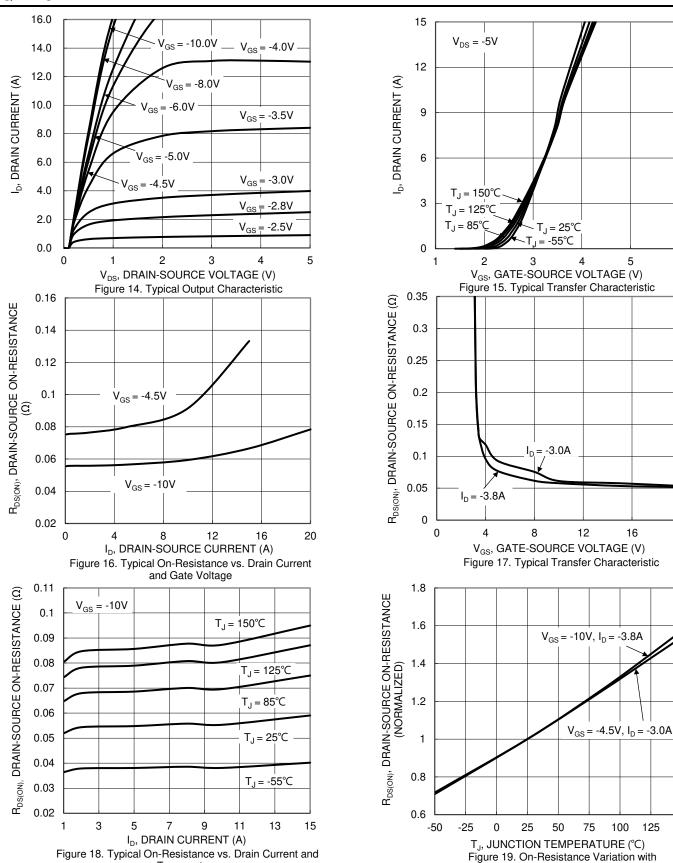


Figure 13. Transient Thermal Resistance

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### **Q2 P-CHANNEL**



Temperature

125

150

100

Junction Temperature

16

20



### Q2 P-CHANNEL (continued)

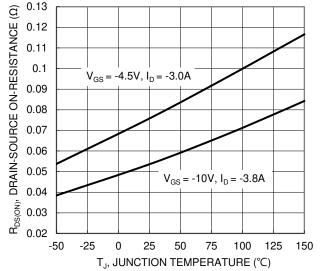
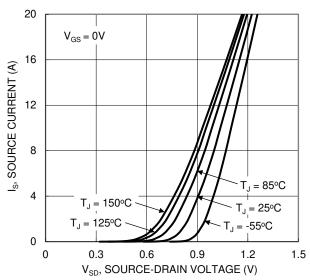


Figure 20. On-Resistance Variation with Temperature



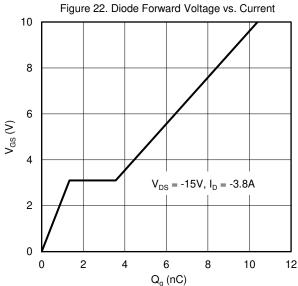
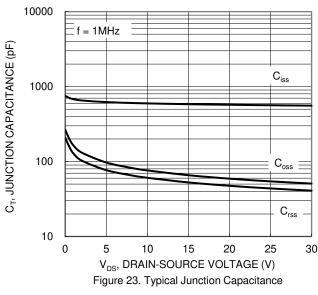
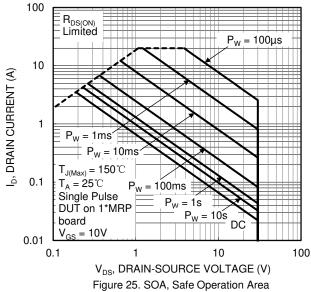


Figure 24. Gate Charge

3  $V_{GS(TH)},$  GATE THRESHOLD VOLTAGE (V) 2.5 2  $I_D = -1mA$ 1.5  $I_{D} = -250 \mu A$ 1 0.5 0 100 -50 -25 0 25 50 75 125 150 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 21. Gate Threshold Variation vs. Temperature

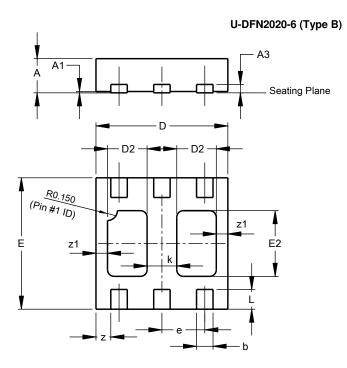






## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

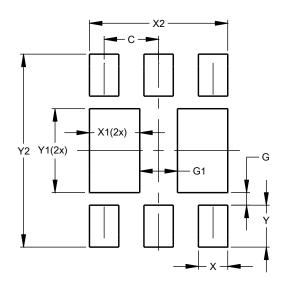


U-DFN2020-6 Type B							
Dim	Min	Max	Тур				
Α	0.545	0.605	0.575				
<b>A</b> 1	0.00	0.05	0.02				
<b>A</b> 3	1	-	0.13				
b	0.20	0.30	0.25				
D	1.95	2.075	2.00				
D2	0.50	0.70	0.60				
е	-	-	0.65				
Е	1.95	2.075	2.00				
E2	0.90	1.10	1.00				
k	1	-	0.45				
L	0.25	0.35	0.30				
Z	-	-	0.225				
z1	-	-	0.175				
All	All Dimensions in mm						

# **Suggested Pad Layout**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

### U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
X	0.350
X1	0.600
X2	1.650
Υ	0.500
Y1	1.000
Y2	2.300



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